

06/Nov/2007

## **GENERAL SPECIFICATION**

# MODULE NO. :

# DEM 320240F SBH-CW-N

CUSTOMER P/N

VERSION NO.	CHANGE DESCRIPTION	DATE	
0	ORIGINAL VERSION	19.05.2006	
1	ADD VERSION	12.06.2006	
2	CHANGED PCB DRAWING	09.11.2006	
3	MODIFY SECTION 3	23.05.2007	
4	UPDATE BACKLIGHT PARAMETER	30.10.2007	
5	UPDATE BACKLIGHT PARAMETER	06.11.2007	

PREPARED BY: ZWY

DATE: 06.11.2007 DATE: 06.11.2007

APPROVED BY: MH

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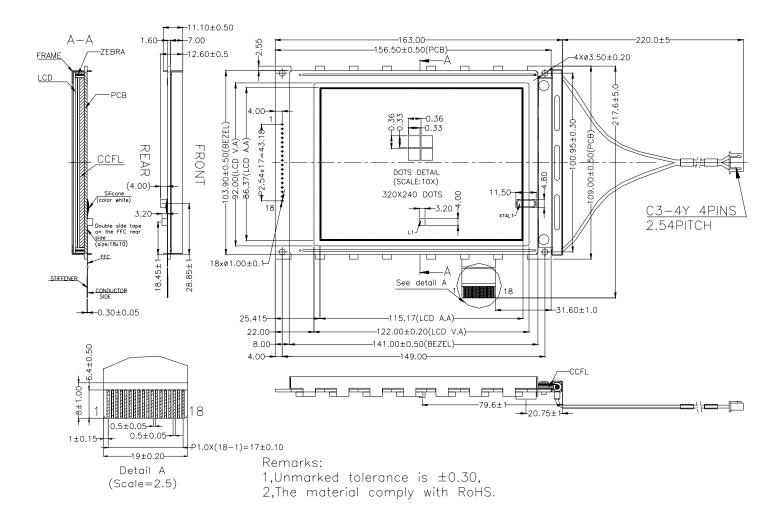
### **1. FUNCTIONS & FEATURES**

MODULE NAME	LCD TYPE
DEM 320240F SBH-CW-N STN-BLUE Transmissive Negative Mo	
Viewing Direction	: 6 o'clock
Driving Scheme	: 1/240 Duty Cycle, 1/16 Bias
Display Format	: 320 x 240 Dots
Power Supply Voltage	: 5.0 Volt (typ.)
LCD Driving Voltage (V <sub>LCD</sub> =V <sub>D</sub>	$_{\rm D}$ -V <sub>0</sub> ) : 24.0 Volt (typ. @ 25°C)
Operating Temperature	: -20°C to +70°C
Storage Temperature	: -30°C to +80°C
Backlight:	: CCFL
Negative Power Generator (dc/d	c) : AIC1652
LCD-Controller on Board	: S1D13700 (Epson)

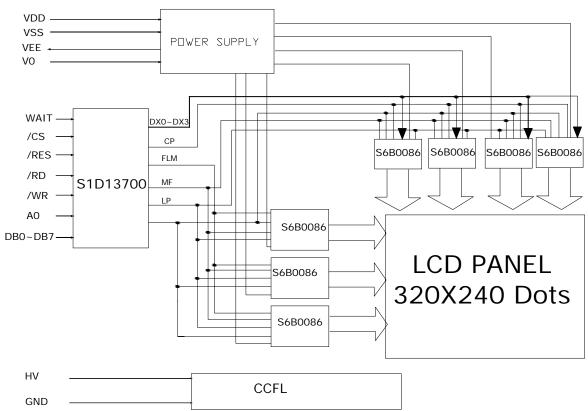
### 2. MECHANICAL SPECIFICATIONS

•	Module Size	: 163.00 x 109.00 x 12.60 mm
•	Dot Size	: 0.33 x 0.33 mm
•	Dot Pitch	: 0.36 x 0.36 mm

### **3. EXTERNAL DIMENSIONS**



### 4. BLOCK DIAGRAM



### **5. PIN ASSIGNMENT**

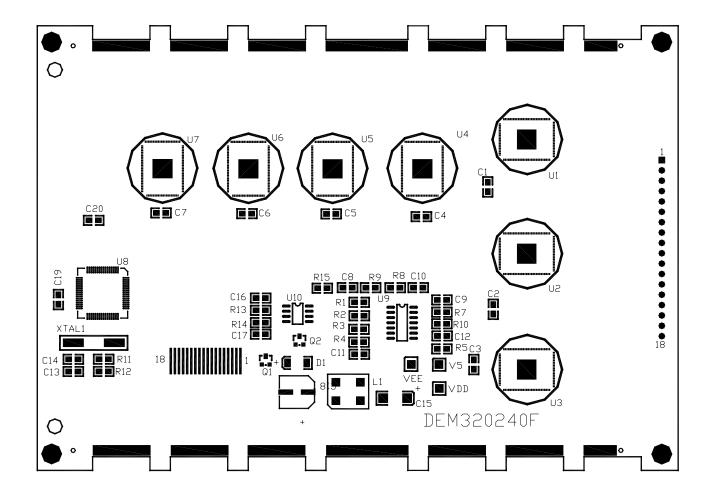
#### **Interface Connector**

Pin No.	Symbol	Function
1	WAIT	Wait
2	VSS	Ground terminal of module
3	VEE	Supply voltage for LCD
4	VDD	Power terminal of module (typ. 5.0 Volt)
5~12	DB7~ DB0	Data bus
13	/WR	Data Write
14	/RD	Data Read
15	A0	Command/Data select
16	V0	LCD contrast adjust voltage
17	/CS	Chip selection
18	/RES	Reset signal

#### **CCFL Connector**

Pin No.	Symbol	Function
1	HV	Power supply voltage for CCFL
2	NC	No used
3	NC	No used
4	GND	Ground line (from inverter)

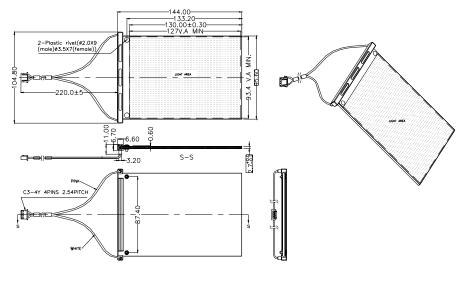
### 6. PCB DRAWING



### **DESCRIPTION:**

- **6.1. The metal-bezel is set on ground when the J1 is closed.** Note: In application module, J1=0 Ohm
- **6.2. The mounting-holes are set on ground when the J2 is closed.** Note: In application module, J2=0 Ohm

### 7. CCFL-BACKLIGHT



	SYMBOL	MIN.	TYP.	MAX.	UNIT	CONDITIONS	
Forward Voltage	V f	288	320	352	V	If=5.0mA	
Forward Current	I f		5.0	6.0	mA		
Lamp Frequency	fosc	33	55	80	KHz		
Power Dissipation	Pd				W		
Luminous Intensity	IV	660	750		cd/m <sup>2</sup>		
Luminous uniform		75	80		%	If=5.0 mA	
Emitted Color	Ec		6000		Κ		
	λp	X=0.305	X=0.320	X=0.335		If=5.0 mA	
Emission Wavelength		Y=0.345	Y=0.360	Y=0.375		$Ta=25^{\circ}C$	
Starting Voltage	480V (	Ta=25 °	'a=25 ℃)				
	640V (	Ta= 0 °C)					
	SYMBOL RATINGS						
Operating Tempe	To	Topr -20°C to +70°C		to +70°C			
	Ts	Tsty -30°C to +80°		to +80°C			

Remarks: 1,Unmarked tolerance is  $\pm 0.30$ 2,The color is white.

### 8. ABSOLUTE MAXIMUM LIMIT

Item	Symbol	MIN	ТҮР	MAX	UNIT
Supply voltage for logic	Vdd-Vss	-0.3		+7.0	V
Supply voltage for LCD	Vdd-V0	-0.3		+30.0	V
Input Voltage	Vi	-0.3		Vdd+0.3	V
Operating temperature	Тор	-20		+70	°C
Storage temperature	Tst	-30		+80	°C

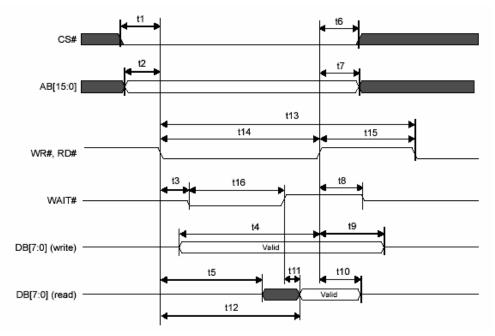
### 9. ELECTRICAL CHARACTERISTICS

Unless otherwise noted.  $V_{SS} = 0V$ 

Item	Combol Condition			Unit		
Item	Symbol	Condition	Min	Туре	Max	
Supply Voltage for logic	Vdd-Vss		2.7	5.0	5.5	V
Supply Voltage for LCD	Vdd -V0		21.5	24.0	28	V
Consumption current	Idd			tbd		mA

### 10. S1D13700 TIMING DIAGRAMS

Generic Bus Direct/Indirect Interface with WAIT # Timing



Generic Bus Direct/Indirect Interface with WAIT # Timing

Symbol	Parameter	Min	Max	Units
t1	CS# setup time	5		ns
t2	AB[15:0] setup time	5		ns
t3	WR#, RD# falling edge to WAIT# driven low	2		ns
t4	DB[7:0] setup time to WR# rising edge (write cycle)	Note1	15	ns
t5	RD# falling edge to DB[7:0] driven (read cycle)	3		ns
t6	CS# hold time	7		ns
t7	AB[15:0] hold time	7		ns
t8	RD#, WR# rising edge to WAIT# high impedance	2	10	ns
t9	DB[7:0] hold time from WR# rising edge (write cycle)	5		ns
t10	DB[7:0] hold time from RD# rising edge (read cycle)	3	14	ns
t11	WAIT# rising edge to valid Data if WAIT# is used		Note 2	ns
t12	RD# falling edge to valid Data if WAIT# is not used		Note 3	ns
t13	RD#, WR# cycle time	Note 4		ns
t14	RD#, WR# pulse active time	5		Ts
t15	RD#, WR# pulse inactive time	Note 5		ns
t16	WAIT# pulse active time		Note 6	ns

Note: (Ts = System clock period)

1. t4min = 2Ts + 5

2. t11max = 1Ts + 5 (for 3.3V) = 1Ts + 7 (for 5.0V)

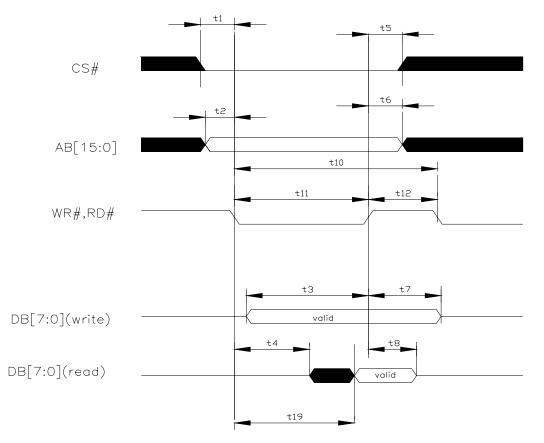
3. t12max = 4Ts + 18 (for 3.3V)= 4Ts + 20 (for 5.0V)

4. t13min = 6Ts (for a read cycle followed by a read or write cycle) = 7Ts + 2 (for a write cycle followed by a write cycle) = 10Ts + 2 (for a write cycle followed by a read cycle)

5. t15min = 1Ts (for a read cycle followed by a read or write cycle) = 2Ts + 2 (for a write cycle followed by a write cycle) = 5Ts + 2 (for a write cycle followed by a read cycle)

6. t16max = 4Ts + 2

### Generic Bus Direct/Indirect Interface without WAIT # Timing



Symbol	Parameter	min	max	Unit
t1	CS# setup time	5		ns
t2	AB[15:0] setup time	5		ns
t3	DB[7:0] setup time to WR# rising edge (write cycle)	Note 1		ns
t4	RD# falling edge to DB[7:0] driven (read cycle)	3		ns
t5	CS# hold time	7		ns
t6	AB[15:0] hold time	7		ns
t7	DB[7:0] hold time from WR# rising edge (write cycle)	5		ns
t8	DB[7:0] hold time from RD# rising edge (read cycle)	3	14	ns
t9	RD# falling edge to valid Data (read cycle)		Note2	ns
t10	RD#, WR# cycle time	Note 3		ns
t11	RD#, WR# pulse active time	5		Ts
t12	RD#, WR# pulse inactive time	Note 4		ns

Note: (Ts = System clock period)

#### 1. t3min = 2Ts + 5

2. t9max = 4Ts + 18 (for 3.3V)

= 4Ts + 20 (for 5.0V)

3. t10min = 6Ts (for a read cycle followed by a read or write cycle)

= 7Ts + 2 (for a write cycle followed by a write cycle)

= 10Ts + 2 (for a write cycle followed by a read cycle)

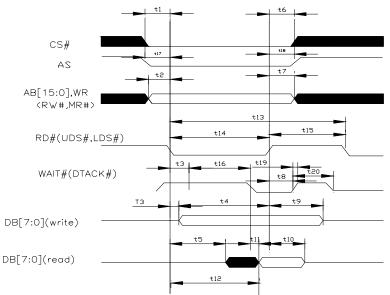
4. t12min = 1Ts (for a read cycle followed by a read or write cycle)

= 2Ts + 2 (for a write cycle followed by a write cycle)

= 5Ts + 2 (for a write cycle followed by a read cycle)

Version: 5

#### MC68K Family Bus Indirect/Direct Interface with DTACK # Timing



Symbol	Parameter	Min	Max	Units
t1	CS# setup time	5		ns
t2	AB[15:0] setup time	5		ns
t3	AS# falling edge to WAIT# driven	2	15	ns
t4	DB[7:0] setup time to RD# rising edge (write cycle)	Note 1		ns
t5	RD# falling edge to DB[7:0] driven (read cycle)	3		ns
t6	CS# hold time	7		ns
t7	AB[15:0] hold time	7		ns
t8	RD# rising edge to WAIT# high impedance if Direct	2	10	ns
	interface and in Power Save Mode			
t9	DB[7:0] hold time from RD# rising edge (write cycle)	5		ns
t10	DB[7:0] hold time from RD# rising edge (read cycle)	2	55	ns
t11	WAIT# falling edge to valid Data if WAIT# is used		Note 2	ns
t12	RD# falling edge to valid Data if WAIT# is not used		Note 3	ns
t13	RD# cycle time	Note 4		ns
t14	RD# pulse active time	5		Ts
t15	RD# pulse inactive time	Note 5		ns
t16	WAIT# pulse inactive time from WAIT# driven		Note 6	Ns
17	AS# setup time	0		ns
18	AS# hold time	0		ns
19	AS# rising edge to WAIT# high de-asserted if not		10	ns
	Direct interface and not in Power Save Mode			
20	WAIT# pulse inactive time	0	Note 7	ns

**Note:** (Ts = System clock period)

1. t4min = 2Ts + 5

2. t11max = 1Ts + 5 (for 3.3V) = 1Ts + 7 (for 5.0V)

3. t12max = 4Ts + 18 (for 3.3V) = 4Ts + 20 (for 5.0V)

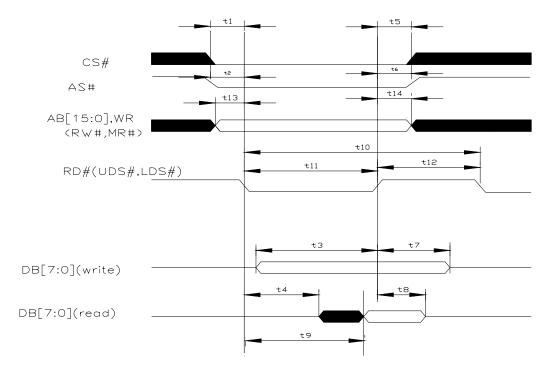
4. t13min = 6Ts (for a read cycle followed by a read or write cycle) = 7Ts + 2 (for a write cycle followed by a write cycle) = 10Ts + 2 (for a write cycle followed by a read cycle)

5. t15min = 1Ts (for a read cycle followed by a read or write cycle) = 2Ts + 2 (for a write cycle followed by a write cycle) = 5Ts + 2 (for a write cycle followed by a read cycle)

6. t16max = 4Ts + 2

7. t20max = 1Ts - 15

### MC68K Family Bus Indirect/Direct Interface without DTACK # Timing



Symbol	Parameter	Min	Max	Units
t1	CS# setup time	5		ns
t2	AB[15:0] setup time	5		ns
t3	DB[7:0] setup time to RD# rising edge (write cycle)	Note 1		ns
t4	RD# falling edge to DB[7:0] driven (read cycle)	3		ns
t5	CS# hold time	7		ns
t6	AB[15:0] hold time	7		ns
t7	DB[7:0] hold time from RD# rising edge (write cycle)	5		ns
t8	DB[7:0] hold time from RD# rising edge (read cycle)	2	55	ns
t9	RD# falling edge to valid Data		Note 2	ns
t10	RD# cycle time	Note 3		ns
t11	RD# pulse active time	5		Ts
t12	RD# pulse inactive time	Note 4		ns
t13	AS# setup time	0		ns
t14	AS# hold time	0		ns

Note: (Ts = System clock period)

1. t3min = 2Ts + 5

2. t9max = 4Ts + 18 (for 3.3V)

= 4Ts + 20 (for 5.0V)

3. t10min = 6Ts (for a read cycle followed by a read or write cycle)

= 7Ts + 2 (for a write cycle followed by a write cycle)

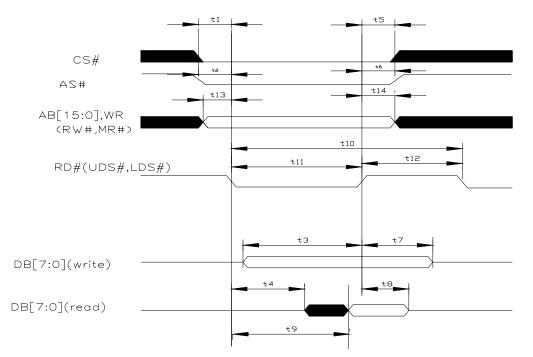
= 10Ts + 2 (for a write cycle followed by a read cycle)

4. t12min = 1Ts (for a read cycle followed by a read or write cycle)

= 2Ts + 2 (for a write cycle followed by a write cycle)

= 5Ts + 2 (for a write cycle followed by a read cycle)

#### M68K Family Bus Indirect Interface Timing



Note:CLK input to the M6800 interface must be driven synchronous to the host microprocessor.

Symbol	Parameter	Min	Max	Units
t1	CS# setup time	5		ns
t2	AB[15:0] setup time	5		ns
t3	DB[7:0] setup time to RD# falling edge (write cycle)	Note 1		ns
t4	RD# falling edge to DB[7:0] driven (read cycle)	3		ns
t5	CS# hold time	7		ns
t6	AB[15:0] hold time	7		ns
t7	DB[7:0] hold time from RD# falling edge (write cycle)	5		ns
t8	DB[7:0] hold time from RD# falling edge (read cycle)	2	55	ns
t9	RD# falling edge to valid Data		Note 2	ns
t10	RD# cycle time	Note 3		ns
t11	RD# pulse active time	5		Ts
t12	RD# pulse inactive time	Note 4		ns
t13	AS# setup time	0		ns
t14	AS# hold time	0		ns

Note: ( Ts = System clock period )

1. t3min = 2Ts + 5

2. t9max = 4Ts + 18 (for 3.3V)

= 4Ts + 20 (for 5.0V)

3. t10min = 6Ts (for a read cycle followed by a read or write cycle)

= 7Ts + 2 (for a write cycle followed by a write cycle)

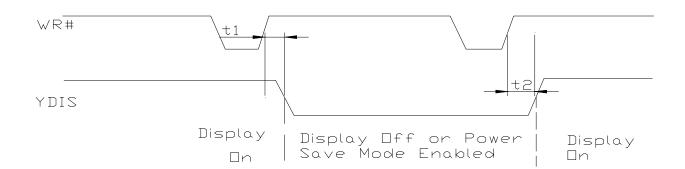
= 10Ts + 2 (for a write cycle followed by a read cycle)

4. t12min = 1Ts (for a read cycle followed by a read or write cycle)

= 2Ts + 2 (for a write cycle followed by a write cycle)

= 5Ts + 2 (for a write cycle followed by a read cycle)

### Power Save Mode/Display Enable Timing



Symbol	Parameter	Min	Max	Units
tla	YDIS falling edge delay for Power Save Mode Enable in Indirect Mode (see Note 1)		2	Frames
t1b	YDIS falling edge delay for Display Off in Indirect Mode (58h)		1Ts+10	ns
t1c	YDIS falling edge delay for Display Off in Direct Mode (see Note 2)		2Ts+10	ns
t2	YDIS rising edge delay for Display On (see Note 2)		2Ts+10	ns

Note: ( Ts = System Clock Period )

1. Power Save Mode is controlled by the Power Save Mode Enable bit, REG[08h] bit 0.

2. Display On/Off is controlled by the Display Enable bit, REG[09h] bit 0.

### 11. INDIRECT ADDRESSING COMMAND

#### **Indirect Addressing Command**

Class	Register Address	Command	Register Description	Control Byte Value	No. of Bytes
System	8000h - 8007h	SYSTEM SET	Initializes device and display	40h	8
Control	8008h	POWER SAVE	Enters standby mode	53h	0
	8009h - 800A	DISP ON/OFF	Enables/disables display and display attributes	58h 59h	1
	800Bh - 8014h	SCROLL	Sets screen block start addresses and sizes	44h	10
<b>D</b> . 1	8015h - 8016h	CSRFORM	Sets cursor type	5Dh	2
Display Control	8017h	CSRDIR	Sets direction of cursor movement	4Ch - 4Fh	0
Control	8018h	OVLAY	Sets display overlay format	5Bh	1
	8019h - 801Ah	CGRAM ADR	Sets start address of character generator RAM	5Ch	2
	801Bh	HDOT SCR	Sets horizontal scroll position	5A	1
Drawing	801Ch - 801Dh	CSRW	Sets cursor address	46h	2
Control	801Eh - 801Fh	CSRR	Reads cursor address	47h	2
	8020h	GRAYSCALE	Sets the Grayscale depth (bpp)	60h	1
Memory		MEMWRITE	Writes to memory	42h	n/a
Control		MEMREAD Reads from memory		43h	n/a

#### **Command Set**

- In general, the internal registers of the SED13700 series are modified as each command parameter is input. However, the microprocessor does not have to set all the parameters of a command and may send a new command before all parameters have been input. The internal registers for the parameters that have been input will have been changed but the remaining parameter registers are unchanged.
- 2-byte parameter (where two bytes are treated as 1 data item) are handled as follows:
  - CSRW, CSRR: Each byte is processed individually. The microprocessor may read or write just the low byte of the cursor address.
  - System Set, Scroll, CGRAM ADR: Both parameter bytes are processed together. If the command is changed after half of the parameter has been input, the single byte is ignored.
- APL and APH are 2-byte parameters, but are treated as two 1-byte parameters.

### **12. CHARACTER GENERATOR**

#### **12.1 CG Characteristics**

#### **Internal Character Generator**

The internal character generator is recommended for minimum system configurations containing a S1D13700, display RAM, LCD panel, single-chip microprocessor and power supply. Since the internal character generator uses a CMOS mask ROM, it is also recommended for low-power applications.

- 5 x 7 pixel font
- 160 JIS standard characters
- Can be mixed with character generator RAM (maximum of 64 CGRAM characters)
- Can be automatically spaced out up to 8 x 16 pixels

#### **Character Generator RAM**

The character generator RAM can be used for storing graphics characters. The character generator RAM can be mapped to any display memory location by the microprocessor, allowing effective usage of unused address space.

- Up to 8 x 8 pixel characters when REG[00h] bit 2 = 0 and 8 x 16 characters when REG[00h] bit 2 = 1
- Can be mapped anywhere in display memory address space if used with the character generator ROM (REG[00h] bit 0 = 0)

#### 12.2 Setting the Character Generator Address

The CGRAM addresses in the display memory address space are not mapped directly from

the address in the Character Generator RAM Start Address registers, REG[19h] -REG[1Ah]. The data to be displayed is at a CGRAM address calculated from (REG[19h] -REG[1Ah]) + character code + ROW select address.

The following tables show the address mapping for CGRAM addresses.

SAG	A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
Character code	0	0	0	0	0	D7	D6	D5	D4	D3	D2	D1	D0	0	0	0
+ROW select address	0	0	0	0	0	0	0	0	0	0	0	0	0	R2	R1	R0
CG RAM address	VA15	VA14	VA13	VA12	VA11	VA10	VA9	VA8	VA7	VA6	VA5	VA4	VA3	VA2	VA1	VA0
		Cha	racter	fonts, 9	num	ber of l	ines	16 (N	12=1,	M1=0	))					
SAG	A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0

Character Fonts Where Number of Lines  $\leq 8$  (REG[00h] bit 2 = 0)

		Cha	nactor	ionis, J	num		mes	10 (1	12-1,	1011-0	,					
SAG	A15	A14	A13	A12	A11	A10	A9	A8	A7	A6	A5	A4	A3	A2	A1	A0
Character code	0	0	0	0	D7	D6	D5	D4	D3	D2	D1	D0	0	0	0	0
+ROW select address	0	0	0	0	0	0	0	0	0	0	0	0	R3	R2	R1	R0
CG RAM address	VA15	VA14	VA13	VA12	VA11	VA10	VA9	VA8	VA7	VA6	VA5	VA4	VA3	VA2	VA1	VA0

R <sub>OW</sub>	R3	R2	R1	R0	<b>↑ ↑</b>
R <sub>OW</sub> 0	0	0	0	0	
R <sub>OW</sub> 1	0	0	0	1	Line 1
R <sub>OW</sub> 2	0	0	1	0	
$\downarrow$	↓ ↓	↓	↓	↓	Line 2
R <sub>OW</sub> 7	0	1	1	1	
R <sub>OW</sub> 8	1	0	0	0	
↓ ↓	↓ ↓	<b>↓</b>	↓	↓	
R <sub>OW</sub> 14	1	1	1	O	
R <sub>OW</sub> 15	1	1	1	1	

Row select address

Note: Lines=1: lines in the character bitmap 8

Lines=2: lines in the character bitmap 9

### 12.3 Character Codes

The following figure shows the character codes and the codes allocated to CG RAM. ALL codes can be used by the CG RAM if not using the internal ROM, but the CGRAM address must be set to 0.

							U	oper	4 b	its						
Lower 4 bits	0	1	2	3	4	5	6	7	8	9	А	В	С	D	Е	F
0				0	@	Р	'	р				-	3	ξ		
1			!	1	А	Q	а	q			o	7	Ŧ	հ		
2			"	2	В	R	b	r			Г	1	IJ	Y		
3			#	3	С	S	с	s			Г	ゥ	Ţ	E		
4			\$	4	D	Т	d	t			×	I	•	4		
5			%	5	Е	U	е	u			•	7	ナ	ユ		
6			&	6	F	V	f	v			7	Л	-	Ε		
7			'	7	G	W	g	w			7	+	<b>x</b>	ラ		
8			(	8	н	Х	h	х			1	7	7	ソ		
9			)	9	1	Y	i	у			ぅ	勹	J	ιU		
A			*	:	J	Ζ	j	z			т	⊐	IJ	$\mathbf{\nu}$		
В			+	;	к	[	k	{			ォ	Ţ	t			
С			,	<	L	¥	Ι	ı I			ч	Ŀ	כ	7		
D				=	М	]	m	}			ㅋ	7	<u>م</u>	ر		
E			-	>	Ν	۸	n	$\rightarrow$			Э	セ	<b>.</b>	`		
F			/	?	0	_	0	$\leftarrow$			עי	צ	マ			
						C	GR/	<b>\M</b> 1	<b></b>			С	GR/	AM2	: <b>†</b>	

**On- chip character codes** 

### 12.4 Internal Character Generator Font

							C	harac	ter co	ode b	its 0 t	to 3					
		0	1	2	3	4	5	6	7	8	9	Α	В	С	D	Е	F
	2								•		••••••	: <b>-</b> ::		:	•••••	=	
	3					~			i i i i i i i i i i i i i i i i i i i			=	=				
	4											• • • •	K				
to 7	5																
bits 4	6								•				K			 	
Character code	7		•===	}•**	•		II	I.,I	<b>!</b> ,,]	:::	•		<				÷
haracte	А					••	=		 _=				7	•			• • • •
C	в		Ţ	•									Ť				
	С					<b>.</b>	<b>-</b>	•••							·`••		••••
	D		Ś							Ņ					•• •	•••	
	1																

Note: The shaded positions indicate characters that have the whole  $6 \cdot 8$  bitmap blackened.

### **13. MICROPROCESSOR INTERFACE**

#### 13.1 System Bus Interface

CNF[4:0], A[15:1], A0, D[7:0], RD#, WR#, AS and CS are used as control signals for the microprocessor data bus. A0 is normally connected to the lowest bit of the system address bus. CNF[4:2] change the operation of the RD# and WR# pins to enable interfacing to either a Generic (Z80), M6800, or MC68K family bus, and should be pulled-up or pulled down

#### Generic

The following table shows the signal states for each function.

Generic Interface Signals

<b>A0</b>	RD#	WR#	Function
1	0	1	Display data and cursor address read
0	1	0	Display data and parameter write
1	1	0	Command write

#### 13.2 M6800 Series

#### M6800 Series interface signals

A0	R/W#	Е	Function
1	1	1	Display data and cursor address read
0	0	1	Display data and parameter write
1	0	1	Command write

#### 13.3 MC68K Series

MC68K series interface signals

A0	RD/WR#	LDS#	Function
1	1	0	Display data and cursor address read
0	0	0	Display data and parameter write
1	0	0	Command write

### 14. LCD MODULES HANDLING PRECAUTIONS

- Please remove the protection foil of polarizer before using.
- Be sure that you are grounded when handing LCM
- The display panel is made of glass. Do not subject it to a mechanical shock by dropping it from a high place, etc.
- If the display panel is damaged and the liquid crystal substance inside it leaks out, do not get any in your mouth. If the substance come into contact with your skin or clothes promptly wash it off using soap and water.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarize carefully.
- To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.
  - -Be sure to ground the body when handling the LCD module.
  - -Tools required for assembly, such as soldering irons, must be properly grounded.
  - -To reduce the amount of static electricity generated, do not conduct assembly and other work under dry conditions.
  - -The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- Storage precautions

When storing the LCD modules, avoid exposure to direct sunlight or to the light of fluorescent lamps. Keep the modules in bags designed to prevent static electricity charging under low temperature / normal humidity conditions (avoid high temperature / high humidity and low temperatures below 0°C). Whenever possible, the LCD modules should be stored in the same conditions in which they were shipped from our company.

### **15. OTHERS**

- Liquid crystals solidify at low temperature (below the storage temperature range) leading to defective orientation of liquid crystal or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subjected to a strong shock at a low temperature.
- If the LCD modules have been operating for a long time showing the same display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. Abnormal operating status can be resumed to be normal condition by suspending use for some time. It should be noted that this phenomena does not adversely affect performance reliability.
- To minimize the performance degradation of the LCD modules resulting from caused by static electricity, etc. exercise care to avoid holding the following sections when handling the modules:
  - Exposed area of the printed circuit board
  - Terminal electrode sections